TO-251



AOI600A70-VB Datasheet

N-Channel 700V (D-S)Super Junction Power MOSFET

PRODUCT SUMMARY					
V_{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.550			

G

S

N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	700	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current (T ₁ = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C		8		
Continuous drain current $(1) = 150^{\circ}$ C)	V _{GS} at 10 V	T _C = 100 °C		5	А	
Pulsed drain current ^a			I _{DM}	24		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy ^b			E _{AS}	370	mJ	
Maximum power dissipation			PD	190	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_{\rm J} = 1$	T _J = 125 °C		50	V/no	
Reverse diode dV/dt ^d			dV/dt	5.1	V/ns	
Soldering recommendations (peak temperature) ^c	For	For 10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 $\Omega,\,I_{AS}$ = 8.0 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

AOI600A70-VB



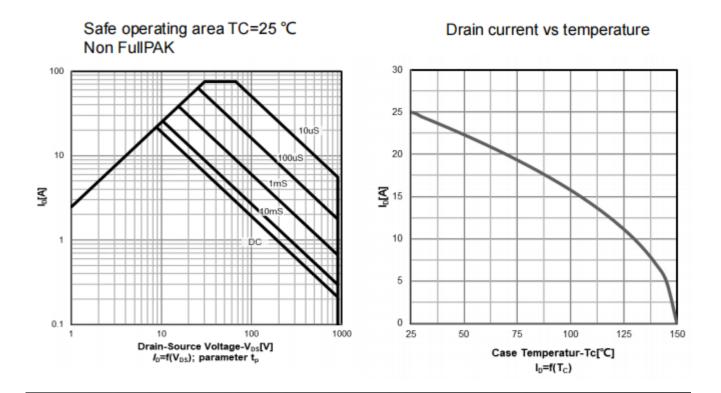
THERMAL RESISTANCE RAT	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 62							
Maximum junction-to-case (drain)	R _{thJC}	- 0.65				- °C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	700	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C	I _D = 1 mA	-	1.08	-	V/°C	
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2.0	-	4.0	V	
			$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	IGSS		$V_{GS} = \pm 30$	V	-	-	± 1	μA	
		V _{DS} =	= 700 V, V ₀	_{as} = 0 V	-	-	1		
Zero gate voltage drain current	IDSS	V _{DS} = 560 V	/, V _{GS} = 0 '	V, T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$			-	0.550	-	Ω	
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 2.5 A		-	8.7	-	S		
Dynamic	•	•					•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2600	-	рF		
Output capacitance	C _{oss}			-	81	-			
Reverse transfer capacitance	C _{rss}			-	9	-			
Effective output capacitance, energy related ^a	C _{o(er)}	- V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	58	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	296	-			
Total gate charge	Qg	V _{GS} = 10 V I _D = 5 A, V _{DS} = 480 V		-	43	122	nC		
Gate-source charge	Q _{gs}			-	16	-			
Gate-drain charge	Q _{gd}				-	20	-		
Turn-on delay time	t _{d(on)}	V_{DD} = 480 V, I _D = 5 A, V _{GS} = 10 V, R _g = 9.1 Ω f = 1 MHz, open drain		-	22	44	ns		
Rise time	t _r			-	24	48			
Turn-off delay time	t _{d(off)}			-	71	142			
Fall time	t _f			-	26	52			
Gate input resistance	R _g			0.3	0.7	1.4	Ω		
Drain-Source Body Diode Characteristi									
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8			
Pulsed diode forward current	I _{SM}			-	-	24	A		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	-			-	416	832	ns	
Reverse recovery charge	Q _{rr}	$T_J = 2$	5 °C, I _F = I	$_{S} = 5 A,$	-	6.4	12.8	μC	
Reverse recovery current	I _{RRM}	dl/dt = 1	100 A/µs, \	/ _R = 25 V	-	27	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

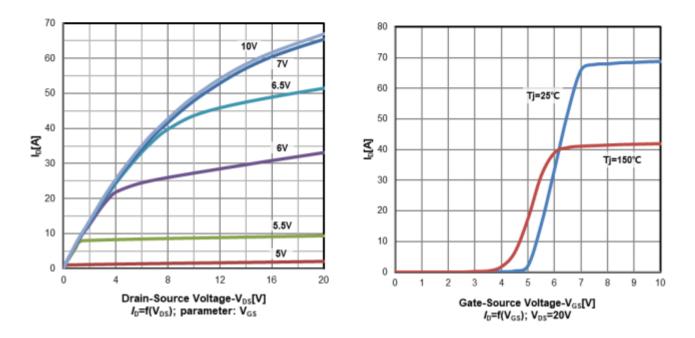


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

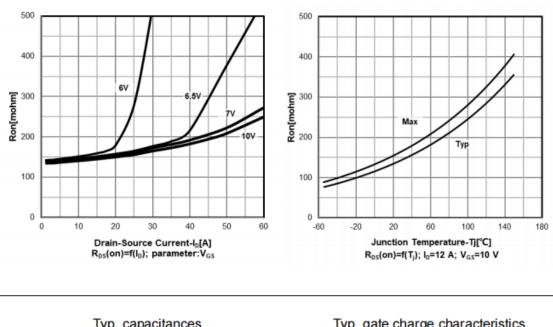


Typ. output characteristics T_i =25 $^{\circ}C$

Typ. transfer characteristics





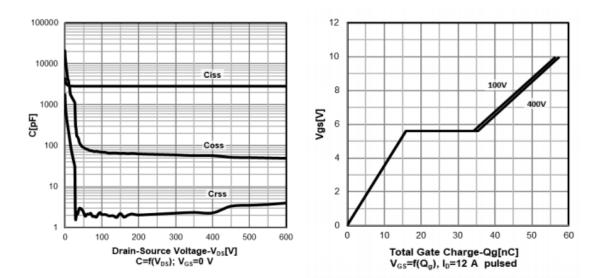


Typ. drain-source on-state resistance

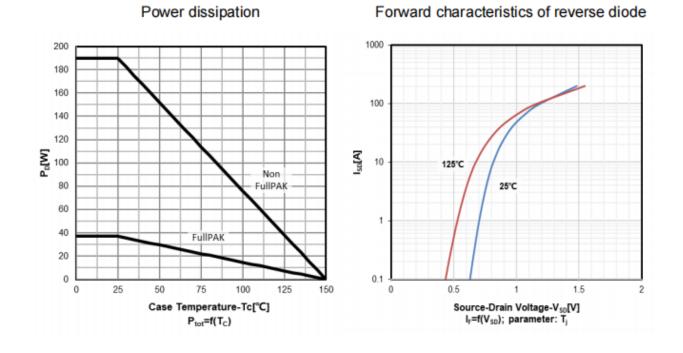
On resistance vs temperature





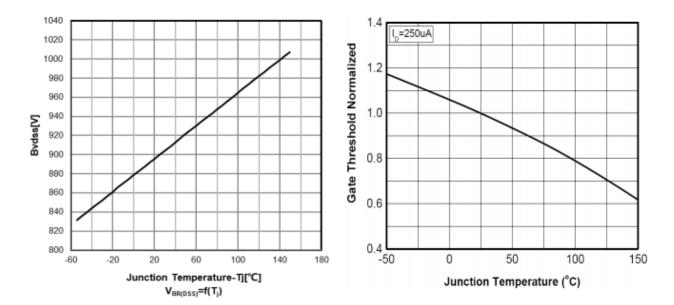






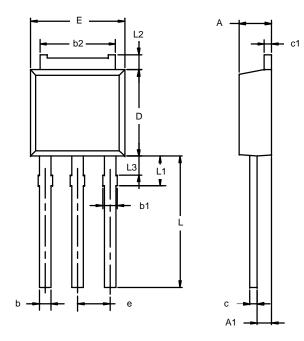
Drain-source breakdown voltage

Normalized V_{GS(th)} characteristics





TO-251



Note: Dimension L3 is for reference only.

	MILLIN	IETERS	INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

服务热线:400-655-8788



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